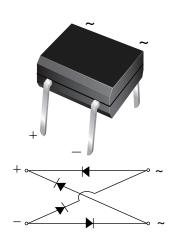


Vishay General Semiconductor

Miniature Glass Passivated Single-Phase Bridge Rectifiers



Case Style MBM

| PRIMARY CHARACTERISTICS | | | | | |
|--|---------------------|--|--|--|--|
| Package | МВМ | | | | |
| I _{F(AV)} | 0.5 A | | | | |
| V _{RRM} | 200 V, 400 V, 600 V | | | | |
| I _{FSM} | 35 A | | | | |
| I _R | 5 μΑ | | | | |
| V _F at I _F = 0.4 A | 1.0 V | | | | |
| T _J max. | 150 °C | | | | |
| Diode variations | Quad | | | | |

FEATURES







• High surge current capability

Solder dip 275 °C max. 10 s, per JESD 22-B106

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for power supply, lighting ballaster, battery charger, home appliances, office equipment, and telecommunication applications.

MECHANICAL DATA

Case: MBM

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: As marked on body

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | | | |
|--|---------------------------|-----------------------------------|---------------|------|------------------|------|--|
| PARAMETER | | SYMBOL | MB2M | MB4M | MB6M | UNIT | |
| Device marking code | | | 2 | 4 | 6 | | |
| Maximum repetitive peak reverse voltage | | V_{RRM} | 200 | 400 | 600 | V | |
| Maximum RMS voltage | | V_{RMS} | 140 | 280 | 420 | V | |
| Maximum DC blocking voltage | | V_{DC} | 200 | 400 | 600 | V | |
| Maximum average forward output rectified current (fig. 1) | on glass-epoxy PCB (1) | | 0.5 | | A | | |
| | on aluminum substrate (2) | I _{F(AV)} | 0.8 | | | | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | | I _{FSM} | 35 | | | А | |
| Rating for fusing (t < 8.3 ms) | | l ² t | 5.0 | | A ² s | | |
| Operating junction and storage temperature range | | T _J , T _{STG} | - 55 to + 150 | | | °C | |

Notes

⁽¹⁾ On glass epoxy PCB mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) pads

⁽²⁾ On aluminum substrate PCB with an area of 0.8" x 0.8" (20 mm x 20 mm) mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) solder pad



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|-------------------------|----------------|--------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | SYMBOL | MB2M | MB4M | MB6M | UNIT |
| Maximum instantaneous forward voltage per diode | I _F = 0.4 A | V _F | 1.0 | | V | |
| Maximum DC reverse current at rated DC blocking | T _A = 25 °C | 5.0 | | | μΑ | |
| voltage per diode | T _A = 125 °C | ЧR | 1 _R 100 | | | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | CJ | 13 | | pF | |

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|----------------------|------------------|----|------|------|--|
| PARAMETER | SYMBOL | . MB2M MB4M MB6M | | МВ6М | UNIT | |
| | R _{0JA} (1) | 85 | | | | |
| Typical thermal resistance | R _{0JA} (2) | 70 | | | °C/W | |
| | R _{0JL} (1) | | 20 | | | |

Notes

- (1) On glass epoxy PCB mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) pads
- (2) On aluminum substrate PCB with an area of 0.8" x 0.8" (20 mm x 20 mm) mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) solder pad

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|---------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| MB2M-E3/45 | 0.22 | 45 | 100 | Tube | | |

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

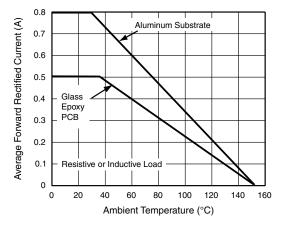


Fig. 1 - Derating Curve for Output Rectified Current

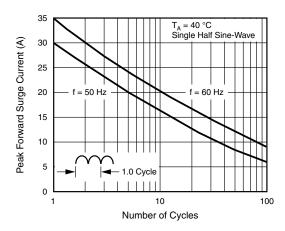


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode



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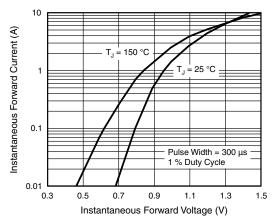


Fig. 3 - Typical Forward Voltage Characteristics Per Diode

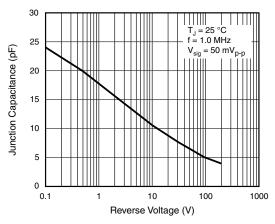


Fig. 5 - Typical Junction Capacitance Per Diode

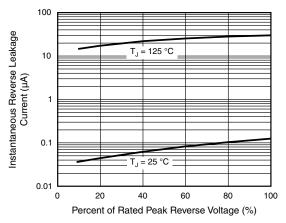
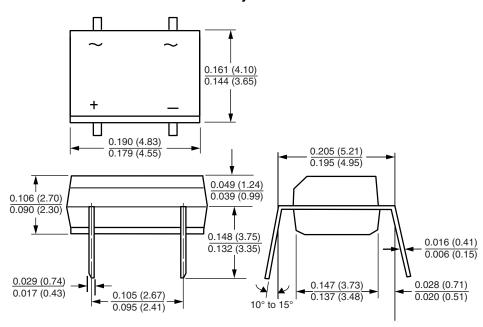


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

Case Style MBM





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